ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	Material Composit © Copyright 2005. IPC, I international and Pan-Am	Bannockb	urn, Illinois. A	ll rights reserved utions.	under both	This docum level parts,	ent is a decl the declarati	aration on enco	of the substance ompasses all low	s within the manufa er level materials fo	cturer listed r which the	d item. Note e manufactur	if the item is an a er has engineering	ssembly with lower responsibility.	
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					terials and	als and Mfg Information			
Supplier Informa	ation														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi											2025-	2025-05-15			
Contact Name			Title - Contact				Phone - Contact*				Emai	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA			Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*			Email	Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
Requester	Requester Item Number Mfr Item		Number Mfr Item Name				Effective I	Date '	Version	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP163AFCS280T2G CSP LDO 250 mA High PSRR, Active			oise and	2025-05-1	5-15 CNQ			0.35	mg	Each			
Manufacturing P	roccess Information	L													
Terminal Plating / Grid Array Material T			erminal Base Alloy J-STD		J-STD-020 MSL	Rating	Peak Process Body Te		Body Temperati	dy Temperature Max Time at Peak		rature Nun	nber of Reflow Cy	cles	
SnAgCu CU Allo			U Alloy	oy 1			260 C 30			sec	seconds 3				
Comments															
level 1 - maximum tin	ne at peak temperature d	luring sol	dering is 10-3	0 seconds											
For more information	n regarding material com	position p	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or [F] Optionally enter the positive (+				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.2396	mg	Supplier	Silicon (Si)	7440-21-3		0.2396	mg
Protection coat	0.009	mg		Polyimide	proprietary data		0.009	mg
Solder Ball	0.09396	mg	Supplier	Silver (Ag)	7440-22-4		0.0024	mg
			Supplier	Tin (Sn)	7440-31-5		0.091	mg
			Supplier	Copper (Cu)	7440-50-8		0.0006	mg
UBM/RDL PCu	0.007	mg	Supplier	copper	7440-66-6		0.007	mg
UBM Sputter	4.4E-4	E-4 mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg